

C0603X120FATACTU

Aliases (CO603X120FATAC7867) SMD Comm X8G HT150C Flex, Ceramic, 12 pF, 1%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.4 mm



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General Information	
Series	SMD Comm X8G HT150C Flex
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	4.6 mg
Shelf Life	78 Weeks
MSL	1

ensions		Specification
Size	0603	Capacitance
	1.6mm +/-0.17mm	Measuremen
	0.8mm +/-0.15mm	Tolerance
	0.8mm +/-0.15mm	Voltage DC
	0.4mm MIN	Dielectric Wit
	0.45mm +/-0.15mm	Temperature
		Temp. Coeffi

Packaging Specifications	
Packaging	T&R

Packaging Quantity

Dime Chip L W T S B

> T&R, 180mm, Paper Tape 4000

Specifications	
Capacitance	12 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	1%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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